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August 20144

FSA3230 — High-Speed USB2.0 / Mobile High-Definition Link (MHL™) with Negative Swing Audio

Features

- Low On Capacitance: 6 pF / 6 pF MHL / USB (Typical)
- Low Power Consumption: 30 μA Maximum
- Supports MHL Rev. 2.0
- MHL Data Rate: 4.0 Gbps
- Audio Swing: -1.5 V to +1.5 V (Typical)
- V_{BUS} Powers Device with No V_{CC}
- Packaged in 16-Lead UMLP (1.8 x 2.6 mm)
- Over-Voltage Tolerance (OVT) on all USB Ports, Up to 5.25 V without External Components

Applications

Cell Phones and Digital Cameras

Description

The FSA3230 is a bi-directional, low-power, high-speed, 3:1, USB2.0, MHL™ and audio switch. Configured as a double-pole, triple-throw (DP3T) switch, it is optimized for switching between high- or full-speed USB, Mobile High-Definition Link sources (per MHL Rev. 2.0 specification) and negative swing capable audio. A Single-Pole, Double-Throw (SPDT) switch is provided for ID. This ID switch provides path to support On-The-Go (OTG) communication for the USB Path OR CBUS for the MHL Path.

The FSA3230 contains special circuitry on the switch I/O pins, for applications where the V_{CC} supply is powered off (V_{CC} =0), that allows the device to withstand an over-voltage condition. This switch is designed to minimize current consumption even when the control voltage applied to the control pins is lower than the supply voltage (V_{CC}). This is especially valuable in mobile applications, such as cell phones; allowing direct interface with the general-purpose I/Os of the baseband processor. Other applications include switching and connector sharing in portable cell phones, digital cameras, and notebook computers.

Ordering Information

Part Number	Top Mark	Operating Temperature Range	Package
FSA3230UMX	LK		16-Lead, Ultrathin Molded Leadless Package (UMLP), 1.8 x 2.6 mm

Analog Symbol

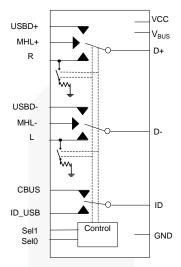


Figure 1. Analog Symbol

Table 1. Data Switch Select Truth Table

SEL1 ⁽¹⁾	SEL0 ⁽¹⁾	Shunt	Function
0	0	Enable	D+/D- connected to USB+/USB-; ID connected to ID_USB
0	1	Disable	D+/D- connected to R/L; ID connected to ID_USB
1	0	Enable	D+/D- connected to MHL+/MHL; ID connected to CBUS
1	1	Enable	D+/D- high impedance; ID Hi-Z

Note:

1. Control inputs should never be left floating or unconnected. To guarantee default switch closure to the USB position, the SEL[0:1] pins should be tied to GND with a weak pull-down resistor (3 $M\Omega$) to minimize static current draw.

D-

ID

Pin Configuration

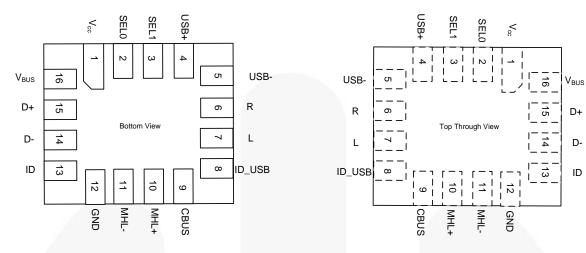


Figure 2. Pin Assignments

Figure 3. Top Through View

Pin Definitions

Pin	Name	Description		
1	V _{CC}	V _{CC} Supply		
2	SEL0	Control Pin		
3	SEL1	Control Pin		
4	USB+	USB Differential Data (Positive)		
5	USB-	USB Differential Data (Negative)		
6	R	Audio R (Negative Swing)		
7	L	Audio L (Negative Swing)		
8	ID_USB	ID for USB Host		
9	CBUS	CBUS for MHL Host		
10	MHL+	MHL Differential Data (Positive)		
11	MHL-	MHL Differential Data (Negative)		
12	GND	Ground		
13	ID	Common Data Path for ID		
14	D-	Common Data Path D-		
15	D+	Common Data Path D+		
16	V _{BUS}	V _{BUS} Pin from Micro-USB Connector		

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit	
V _{CC} , V _{BUS}	Supply Voltage		-0.5	6.0	V	
V _{CNTRL}	DC Input Voltage (SEL[1:0]) ⁽²⁾		-0.5	V _{CC}	V	
		USB	-0.5	6.0		
V	DC Switch I/O Voltage ⁽²⁾	MHL	-0.5	6.0	V	
V_{SW}	DC Switch I/O Voltage	AUDIO	-2.0	3		
		ID	-0.5	6.0	V	
I _{IK}	DC Input Diode Current		-50		mA	
		USB		60	mA	
I _{OUT}	Switch DC Output Current (Continuous)	MHL		60	mA	
	J	AUDIO	1	60	mA	
	Switch DC Output Peak Current (Pulsed at 1ms Duration, <10% Duty Cycle)	USB		150	mA	
I _{OUTPEAK}		MHL		150	mA	
	(1 dised at 1115 Duration, <10 % Duty Cycle)	AUDIO		150	mA	
T _{STG}	Storage Temperature		-65	+150	°C	
MSL	Moisture Sensitivity Level: JEDEC J-STD-020A			1		
	Human Body Model, JEDEC: JESD22-A114	All Pins		3.5		
505	IEC 61000-4-2, Level 4, for D+/D- and V _{CC} Pins ⁽³⁾	Contact		8	1	
ESD	IEC 61000-4-2, Level 4, for D+/D- and V _{CC} Pins ⁽³⁾	Air		15	kV	
	Charged Device Model, JESD22-C101			2		

Notes:

- 2. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed. V_{SW} refers to analog data switch paths (USB, MHL, and audio).
- 3. Testing performed in a system environment using TVS diodes.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V _{BUS}	Supply Voltage Running from V _{BUS} Voltage	4.2	5.25	V
Vcc	Supply Voltage Running from V _{CC}	2.5	4.5	V
t _{RAMP(VBUS)}	Power Supply Slew Rate from V _{BUS}	100	1000	µs/V
t _{RAMP(VCC)}	Power Supply Slew Rate from V _{CC}	100	1000	μs/V
Θ_{JA}	Thermal Resistance, Junction to Ambient		283	C°/W
$\Theta_{\sf JC}$	Thermal Resistance, Junction to Case		145	C°/W
V_{CNTRL}	Control Input Voltage (SEL[1:0]) ⁽⁴⁾	0	4.5	V
$V_{SW(USB)}$	Switch I/O Voltage (USB and ID Switch Path)	-0.5	3.6	V
V _{SW(MHL)}	Switch I/O Voltage (MHL Switch Path)	1.65	3.45	V
$V_{SW(AUD)}$	Switch I/O Voltage (Audio Switch Path)	-1.5	3.0	V
T_A	Operating Temperature	-40	+85	°C

Note:

4. The control inputs must be held HIGH or LOW; they must not float.

DC Electrical Characteristics

All typical value are at T_A=25°C unless otherwise specified.

Cumbal	Doromotor	Condition	V _{cc}	T _A =- 40°C to +85°C			I Imit
Symbol	mbol Parameter Condition (V)	(V)	Min.	Тур.	Max.	Unit	
V _{IK}	Clamp Diode Voltage	I _{IN} =-18 mA	2.5			-1.2	V
V _{IH}	Control Input Voltage High SEL[1:0]		2.5 to 4.50	1.0			V
V _{IL}	Control Input Voltage Low SEL[1:0]		2.5 to 4.50			0.5	٧
I _{IN}	Control Input Leakage SEL[1:0]	V _{SW} (USB/MHL)=0 to 3.6 V, V _{SW} (AUD)=0 to 3.0 V, V _{CNTRL} =0 to V _{CC}	4.5	-0.5		0.5	μΑ
I _{OZ(MHL)}	Off-State Leakage for Open MHL Data Paths	V_{SW} =1.65 \leq MHL \leq 3.45 V SEL[1:0]= V_{CC}	4.5	-1		1	μA
I _{OZ(USB)}	Off-State Leakage for Open USB Data Paths	V_{SW} =0 \leq USB \leq 3.6 V SEL[1:0]= V_{CC}	4.5	-0.5		0.5	μA
I _{OZ(ID)}	Off-State Leakage for Open ID Data Paths	$\label{eq:sw} \begin{array}{l} V_{\text{SW}} {=} 0 \leq \text{ ID} \leq 3.6 \text{ V}, \\ \text{SEL}[1:0] {=} V_{\text{CC}} \end{array}$	4.5	-1		1	μA
I _{CL(MHL)}	On-State Leakage for Closed MHL Data Paths ⁽⁵⁾	V_{SW} =1.65 \leq MHL \leq 3.45 V, SEL0=GND, SEL1= V_{CC} , Other Side of Switch Float	4.5	-0.75		0.75	μΑ
I _{CL(USB)}	On-State Leakage for Closed USB Data Paths ⁽⁵⁾	$V_{SW}=0 \le USB \le 3.6 \text{ V}$ SEL[1:0]=GND, Other Side of Switch Float	4.5	-0.75		0.75	μΑ

Continued on the following page...

DC Electrical Characteristics

All typical value are at T_A=25°C unless otherwise specified.

O. make al	Domester	On whiting	V _{cc}	T _A =- 40°C to +85°C			1110:4
Symbol	Parameter	Condition	(V)	Min.	Тур.	Max.	Unit
I _{CL(AUD)}	On-State Leakage for Closed ⁽⁵⁾ AUDIO Data Path	V_{SW} =-1.5 \leq R/L \leq 1.5 V SEL1=GND, SEL0=V _{CC} , Other Side of Switch Float	4.5	-1.0		1.0	μA
I _{CL(ID)}	On-State Leakage for Closed ID Data Paths ⁽⁵⁾	V_{SW} =0 \leq ID \leq 3.6 V, SEL[1:0]=00, 01 or 10	4.5	-1.0		1.0	μA
I _{OFF}	Power-Off Leakage Current (All I/O Ports)	V _{SW} (USB/MHL)=0 to 3.6 V, V _{SW} (AUD)=0 to 3.0 V, Figure 4	0	-1		1	μΑ
R _{ON(USB)}	HS Switch On Resistance (USB to D Path)	V _{SW} =0.4 V, I _{ON} =-8 mA, SEL[1:0]=GND, Figure 5	2.5		3.9	6.5	Ω
R _{ON(MHL)}	HS Switch On Resistance (MHL to D Path)	V _{SW} =V _{CC} -1050 mV, SEL0=GND, SEL1=V _{CC} , I _{ON} =-8 mA, Figure 5	2.5		5		Ω
R _{ON(Audio)}	Audio Switch On Resistance (R/L Path)	V _{SW} =-1.5 V to 1.5 V, SEL1=GND, SEL0=V _{CC} , I _{ON} =-24 mA, Figure 5	2.5		4		Ω
R _{ON(ID)}	ID Switch On Resistance (ID_USB or CBUS to D Path)	V _{SW} =3 V, I _{ON} =-8 mA, SEL[1:0]=00, 01 or 10, Figure 5	2.5		12		Ω
$\Delta R_{\text{ON(MHL)}}$	Difference in R _{ON} Between MHL Positive-Negative	V _{SW} =V _{CC} -1050 mV, SEL0=GND, SEL1=V _{CC} , I _{ON} =-8 mA, Figure 5	2.5		0.03		Ω
$\Delta R_{ON(USB)}$	Difference in R _{ON} Between USB Positive-Negative	V _{SW} =0.4 V, I _{ON} =-8 mA, SEL[1:0]=GND, Figure 5	2.5		0.18		Ω
$\Delta R_{\text{ON(ID)}}$	Difference in R _{ON} Between ID_USB and CBUS	V _{SW} =3 V, I _{ON} =-8 mA, SEL[1:0]=00, 01 or 10, Figure 5	2.5		0.4		Ω
R _{ONF(MHL)}	Flatness for R _{ON} MHL Path	V_{SW} =1.65 to 3.45 V, SEL0=GND, SEL1= V_{CC} , I_{ON} =-8 mA, Figure 5	2.5		1		Ω
R _{ONFA(AUDIO)}	Flatness for R _{ON} Audio Path	V _{SW} =-1.5 V to 1.5 V, SEL1=GND, SEL0=V _{CC} , I _{ON} =-24 mA, Figure 5	2.5		0.1	7	Ω
R _{SH}	Shunt Resistance		3.6		125	200	Ω
I _{CC}	Quiescent Current	V _{CNTRL} =0 or 4.5 V, I _{OUT} =0	4.5			30	μΑ
la	Delta Increase in Quiescent	V _{CNTRL} =1.65 V, I _{OUT} =0	4.5			18	^
I _{CCT}	Current per Control Pin	V _{CNTRL} =2.5 V, I _{OUT} =0	4.5			10	μA

Note:

5. For this test, the data switch is closed with the respective switch pin floating.

AC Electrical Characteristics

All typical value are at T_A=25°C unless otherwise specified.

Symbol	Donomotor	Condition	v 00	T _A =- 40°C to +85°C			Unit
Symbol	Parameter	rameter Condition V _{CC} (V)		Min.	Тур.	Max.	Unit
t _{ONUSB}	USB Turn-On Time, SEL[1:0] to Output	$\begin{array}{c} \text{R}_\text{L}{=}50~\Omega,~\text{C}_\text{L}{=}5\text{pF},~\text{V}_\text{SW(USB)}{=}0.8~\text{V},\\ \text{V}_\text{SW(MHL)}{=}3.3~\text{V},~\text{V}_\text{SW(AUD)}{=}1.5~\text{V},\\ \text{Figure 6, Figure 7} \end{array}$	2.5 to 3.6		445	600	ns
t _{OFFUSB}	USB Turn-Off Time, SEL[1:0] to Output	$\begin{array}{c} \text{R}_\text{L}\text{=}50~\Omega,~\text{C}_\text{L}\text{=}5~\text{pF},~\text{V}_\text{SW(USB)}\text{=}0.8~\text{V},\\ \text{V}_\text{SW(MHL)}\text{=}3.3~\text{V},~\text{V}_\text{SW(AUD)}\text{=}1.5~\text{V},\\ \text{Figure 6, Figure 7} \end{array}$	2.5 to 3.6		445	600	ns
t _{ONAUD}	AUDIO Turn-On Time, SEL[1:0] to Output	$ \begin{array}{c} R_L{=}50~\Omega,~C_L{=}5~pF,~V_{SW(USB)}{=}0.8~V,\\ V_{SW(MHL)}{=}3.3~V,~V_{SW(AUD)}{=}1.5~V,\\ Figure~6,~Figure~7 \end{array} $	2.5 to 3.6		445	600	ns
toffaud	AUDIO Turn-Off Time, SEL[1:0] to Output	$\begin{array}{c} R_L{=}50~\Omega,~C_L{=}5~pF,~V_{SW(USB)}{=}0.8~V,\\ V_{SW(MHL)}{=}3.3~V,~V_{SW(AUD)}{=}1.5~V,\\ Figure~6,~Figure~7 \end{array}$	2.5 to 3.6		445	600	ns
tonmhl	MHL Turn-On Time, SEL[1:0] to Output	$\begin{array}{c} R_L{=}50~\Omega,~C_L{=}5~pF,~V_{SW(USB)}{=}0.8~V,\\ V_{SW(MHL)}{=}3V,~V_{SW(AUD)}{=}1.5~V,\\ Figure~6,~Figure~7 \end{array}$	2.5 to 3.6		445	600	ns
t _{OFFMHL}	MHL Turn-Off Time, SEL[1:0] to Output	$\begin{array}{c} R_L{=}50~\Omega,~C_L{=}5~pF,~V_{SW(USB)}{=}0.8~V,\\ V_{SW(MHL)}{=}3.3~V,~V_{SW(AUD)}{=}1.5~V,\\ Figure~6,~Figure~7 \end{array}$	2.5 to 3.6		445	600	ns
t _{PD}	Propagation Delay ⁽⁶⁾	C_L =5 pF, R_L =50 Ω , Figure 6, Figure 8	2.5 to 3.6		0.25		ns
t _{BBM}	Break-Before-Make ⁽⁶⁾	R_L =50 Ω , C_L =5 pF, V_{AUD} =1.5 V, V_{MHL} =3.3 V, V_{USB} =0.8 V, Figure 9	2.5 to 3.6		350		ns
O _{IRR(MHL)}	Off Isolation ⁽⁶⁾	V_S =1 $V_{pk\text{-}pk}$, R_L =50 Ω , f=240 MHz, Figure 10	2.5 to 3.6		-41		dB
O _{IRR(USB)}	On isolation	V_S =400 m V_{pk-pk} , R $_L$ =50 Ω , f=240 MHz, Figure 10	2.5 to 3.6	-/	-38		dB
Xtalk _{MHL}		V_S =1 $V_{pk\text{-}pk}$, R_L =50 Ω , f=240 MHz, Figure 11	2.5 to 3.6		-37		dB
Xtalk _{USB}	Non-Adjacent Channel Crosstalk ⁽⁶⁾	V_S =400 m V_{pk-pk} , R $_L$ =50 Ω , f=240 MHz, Figure 11	2.5 to 3.6		-34		dB
Xtalk _{AUD}		V_S =100 m V_{RMS} , R_L =32 Ω , f=20 kHz, Figure 11	2.5 to 3.6		-70		dB
THD	Total Harmonic Distortion	R_T =32 Ω , V_{SW} =2 V_{pk-pk} , f=20 Hz to 20 kHz, V_{BIAS} =0 V	2.5		0.03		%
	0 0"	V_{IN} =1 $V_{\text{pk-pk}}$, Common Mode Voltage= V_{CC} - 1.1 V, MHL Path, R _L =50 Ω , C _L =0 pF, Figure 12			2.0	6	GHz
BW	S _{DD21} Differential -3db Bandwidth ⁽⁶⁾	V_{IN} =400 m $V_{\text{pk-pk}}$, Common Mode Voltage=0.2 V, USB Path, R _L =50 Ω , C _L =0 pF, Figure 12	2.5 to 3.6		2.0		GHZ
		AUDIO Path, R _L =50 Ω, C _L =0p F			50		MHz

Note:

6. Guaranteed by characterization.

USB High-Speed AC Electrical Characteristics

All typical value are at T_A=25°C unless otherwise specified.

Symbol	Parameter	Condition	V _{cc} (V)	Тур.	Unit
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁷⁾	C _L =5 pF, R _L =50 Ω, Figure 13	3.0 to 3.6	3	ps
tı	Total Jitter ⁽⁷⁾	R _L =50 Ω, C _L =5 pF, t _R =t _F =500 ps (10-90%) at 480 Mbps, PN7	3.0 to 3.6	15	ps

Note:

7. Guaranteed by characterization.

MHL AC Electrical Characteristics

All typical value are at T_A=25°C unless otherwise specified.

Symbol	Parameter	Condition	V _{cc} (V)	Тур.	Unit
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁸⁾	$\mbox{R}_{\mbox{\scriptsize PU}}\!\!=\!\!50~\Omega$ to $\mbox{V}_{\mbox{\scriptsize CC}},~\mbox{C}_{\mbox{\scriptsize L}}\!\!=\!\!0~\mbox{\scriptsize pF}$	3.0 to 3.6	3	ps
t _J	Total Jitter ⁽⁸⁾	f=2.25 Gbps, PN7, R _{PU} =50 Ω to V _{CC} , C _L =0 pF	3.0 to 3.6	26	ps

Note:

8. Guaranteed by characterization.

Capacitance

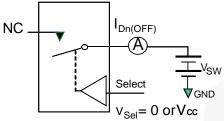
All typical value are at T_A=25°C unless otherwise specified.

Symbol	Parameter	Condition	Тур.	Unit
C _{IN}	Control Pin Input Capacitance ⁽⁹⁾	V _{CC} =0 V, f=1 MHz	1.5	
C _{ON(USB)}	USB Path On Capacitance ⁽⁹⁾	V _{CC} =3.3 V, f=240 MHz, Figure 14	6.0	
C _{OFF(USB)}	USB Path Off Capacitance ⁽⁹⁾	V _{CC} =3.3 V, f=240 MHz, Figure 15	2.5	7
C _{ON(MHL)}	MHL Path On Capacitance ⁽⁹⁾	V _{CC} =3.3 V, f=240 MHz, Figure 14	6.0	
C _{OFF(MHL)}	MHL Path Off Capacitance ⁽⁹⁾	V _{CC} =3.3 V, f=240 MHz, Figure 15	2.5	pF
C _{ON(AUD)}	Audio Path On Capacitance ⁽⁹⁾	V _{CC} =3.3 V, f=1 MHz, Figure 14	10	
C _{OFF(AUD)}	Audio Path Off Capacitance ⁽⁹⁾	V _{CC} =3.3 V, f=1 MHz, Figure 15	2.5	
C _{ON(ID)}	ID Path On Capacitance ⁽⁹⁾	V _{CC} =3.3 V, f =1 MHz, Figure 14	3.5	
C _{OFF(ID)}	ID Path Off Capacitance ⁽⁹⁾	V _{CC} =3.3 V, f =1 MHz, Figure 15	1.5	-1

Note:

9. Guaranteed by characterization.

Test Diagrams



**Each switch port is tested separately

 D_n V_{SW} GND Select **GND** $V_{SEL} = 0$ or Vcc $R_{ON} = V_{ON} / I_{ON}$

HSD_n or R/L V_{ON}

Figure 4. Off Leakage

Figure 5. On Resistance

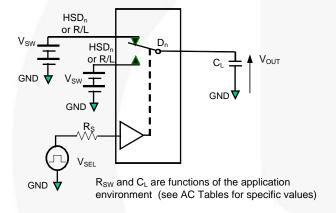


Figure 6. AC Test Circuit Load

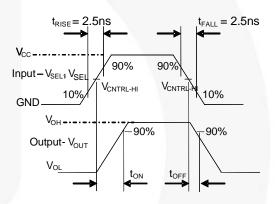


Figure 7. Turn-On / Turn-Off Waveforms

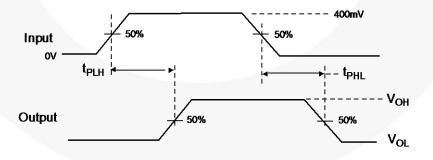


Figure 8. Propagation Delay (t_Rt_F - 500ps)

10. HSD_n refers to the high-speed data USB or MHL paths.

Test Diagrams

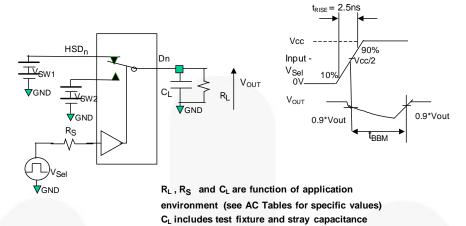
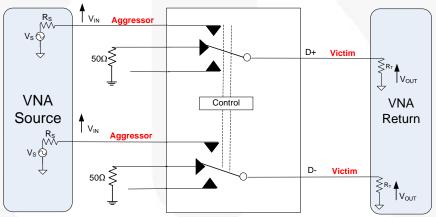
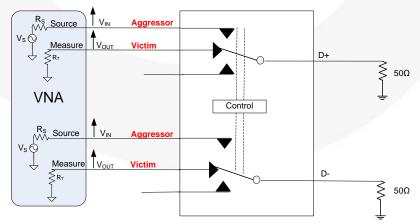


Figure 9. Break-Before-Make Interval Timing



 V_S , R_S and R_T are functions of the application environment (see AC/DC Tables for values). Off Isolation = 20 Log (V_{OUT} - V_{IN})

Figure 10. Channel Off Isolation (SDD21)

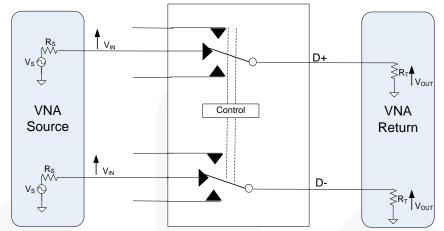


VS, RS and RT are functions of the application environment (see AC/DC Tables for values).

Off Isolation = 20 Log (VOUT - VIN)

Figure 11. Non-Adjacent Channel-to-Channel Crosstalk (SDD21)

Test Diagrams



V_S, R_S and R_T are functions of the application environment (see AC/DC Tables for values).

Figure 12. Insertion Loss (SDD21)

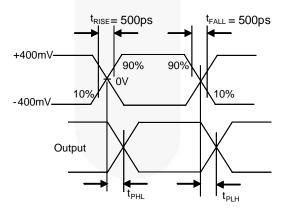


Figure 13. Intra-Pair Skew Test t_{SK(P)}

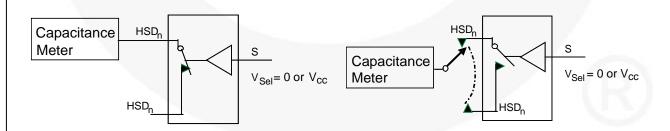


Figure 14. Channel On Capacitance

Figure 15. Channel Off Capacitance

Functional Description

Insertion Loss

One of the key factors for using the FSA3230 in mobile digital video applications is the small amount of insertion loss experienced by the received signal as it passes through the switch. This results in minimal degradation of the received eye. One of the ways to measure the quality of the high data rate channels is using balanced ports and four-port differential S-parameter analysis, particularly SDD21.

Bandwidth is measured using the S-parameter SDD21 methodology.

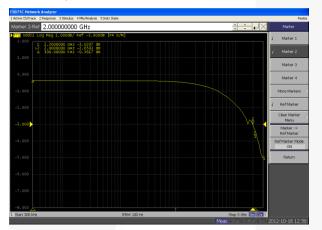


Figure 16. MHL Path SDD21 Insertion Loss Curve

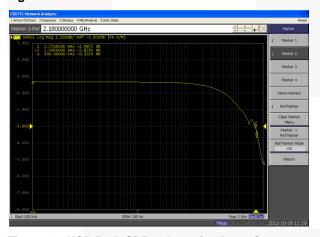


Figure 17. USB Path SDD21 Insertion Loss Curve

Typical Applications

Figure 18 shows the FSA3230 utilizing the V_{BUS} from the micro-USB connection. The 3 $M\Omega$ resistors are used

to ensure, for manufacturing test via the micro-USB connector, that the FSA3230 configures for connectivity to the baseband or application processor. Figure 19 shows the configuration for the FSA3230 "self powered" by battery only.

Switch Power Operation

In normal operation, the FSA3230 is powered from the V_{CC} pin, which typically is derived from a regulated power management device. In special circumstances, such as production test or system firmware upgrade, the device can be powered from the V_{BUS} pin. If both V_{CC} and V_{BUS} pins are present, V_{CC} is selected as the power source and V_{BUS} is ignored (see Table 2).

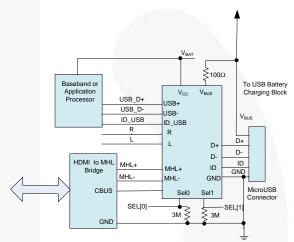


Figure 18. Application Using V_{BUS}

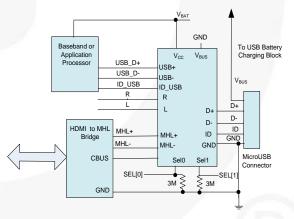
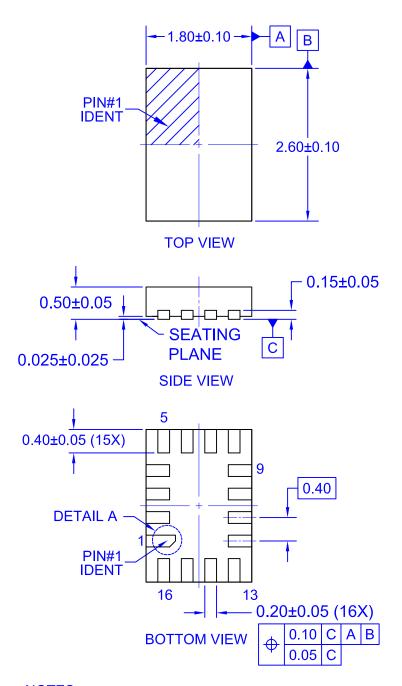


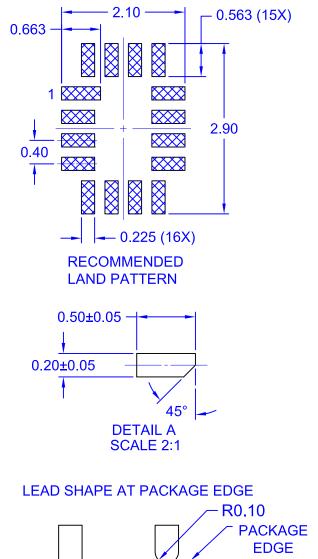
Figure 19. "Self-Powered" Application Using V_{BAT}

Table 2. Switch Power Selection Truth Table

V _{cc}	V _{BUS}	Switch Power Source
0	0	No Switch Power, Switch Paths High Z
0	1	V_{BUS}
1	0	V _{CC}
1	1	V _{CC}

Description	Nominal Values for MKT-UMLP16A Rev5 (mm)
Overall Height	0.50
Package Standoff	0.012
Lead Thickness	0.15
Lead Width	0.20
Lead Length	0.40
Lead Pitch	0.40
Body Length (Y)	Min: 2.50, Nom: 2.60, Max: 2.70
Body Width (X)	Min: 1.70, Nom: 1.80, Max: 1.90





LEAD

OPTION 2

SCALE 2:1

NOTES:

- A. PACKAGE DOES NOT FULLY CONFORM TO JEDEC STANDARD.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- D DRAWING FILENAME: MKT-UMLP16ArevG.
- E. TERMINAL SHAPE MAY VARY ACCORDING TO PACKAGE SUPPLIER, SEE TERMINAL SHAPE VARIANTS.

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OPTION 1

SCALE 2:1



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